



Comparison of Chip to Chip COM Transmitter with Tx specifications.

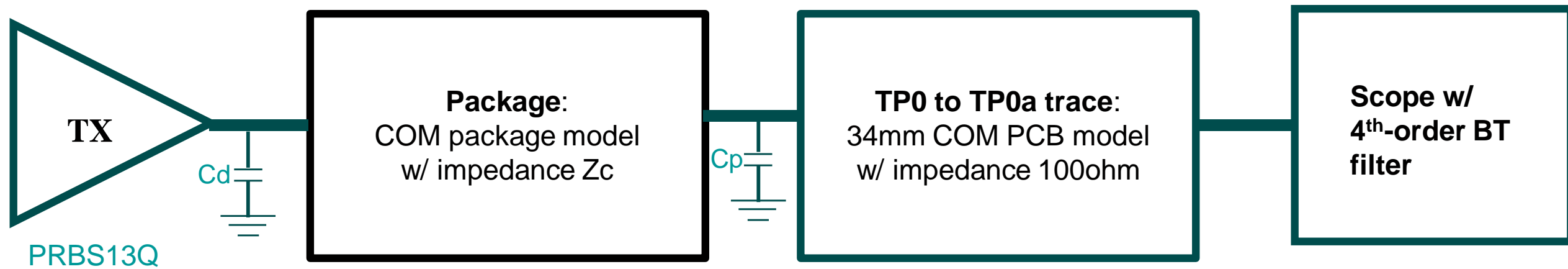
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- **In order to close the Chip to Chip budget it is important that the Tx used in COM is no better than the worst case Tx allowed by the Tx specifications.**
- **This presentation takes the Tx used in COM and simulates the performance that would be measured at Test point TP0a.**
- **The simulations and analysis were performed in a mixture of ADS and Matlab.**
- **The effect of changing the values of R_d (die impedance) and Z_c (package trace impedance) was investigated to investigate how manufacturing tolerances would change the results.**
- **The Value of A_v was adjusted so that V_f (the steady state voltage) was the same for all the combinations of R_d and Z_c .**

Transmitter simulation block diagram



Transmitter including package and PCB trace measured w/ 4th-order BT filter

53.125G PAM4 Transmitter Characteristics @ TP0a w/o TX Equalization: measured w/ 4th order 33GHz BT Filter

	Simulated PRBS13Q @ TP0a						
Parameters	53.125G Gaussian TX Filter Risetime 13ps; 30mm package; Cd 0.18pF; Cp 0.11pF					Units	SPEC (Table 120D-1)
Rd	55	50	45	50	55	ohm	
Zc_pkg	90	100	110	95	80	ohm	
Av	0.438	0.416	0.395	0.416	0.441	V	
Sigma-e	0.042	0.033	0.039	0.041	0.034	mV	
Vf (steady-state voltage)	0.400	0.400	0.400	0.400	0.400	V	0.4V= Vf <=0.6V
Pmax (Linear fit pulse peak)	0.303	0.303	0.301	0.303	0.302	V	
Differential Peak to Peak Voltage	0.801	0.801	0.800	0.800	0.802	V	<=1.2V
Pmax/Vf	0.758	0.757	0.753	0.759	0.755	N/A	>=0.736
SNR_{isi}	36.07	39.89	42.76	38.68	33.42	dB	<=38dB
SNDR (@ Sigman = 0)	77.11	79.17	77.67	77.5	79.04	dB	>=31dB
Sigma-n (for SNDR 31dB@TP0a)	8.534	8.538	8.493	8.551	8.517	mV	
TXSNR@die (to create above sigma-n)	31.00	31.00	31.00	31.00	31.00	dB	

Conclusions.

- **The package and die impedances only have a small affect on the P_{max}/V_f ratio and the existing spec is too relaxed. It should be increased to 0.76**
- **With the current values for R_c and Z_c the value of A_v is too high. A_v and A_{fe} values in COM should be reduced to 0.44**
- **The Sigma-e (with $N_p=200$) is negligible for all the combinations. The SNDR specification is controlling noise, crosstalk and non-linearities. Having $SNDR=TxSNR=31dB$ is fine provided the Tx specification for SNR_{ISI} is no lower than the value calculated from the parameters used in COM. (36dB with the present COM parameters). However requiring SNDR to be a higher value than the TxSNR used in COM would allow a smaller value of SNR_{ISI} .**



Backup.

Tp0 to Tp0a Insertion loss.

